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Part Number:

5024269030

Status:

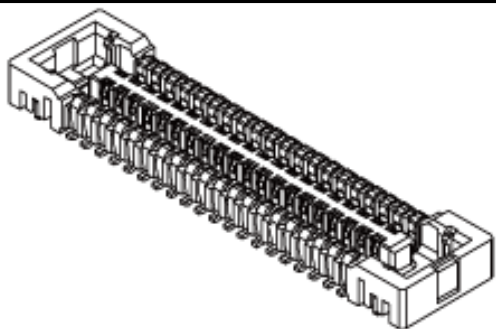
Active

Overview:

slimstack_mm016_pitch

Description:

0.40mm (.016") Pitch SlimStack™ Board-to-Board Receptacle, SMT, Dual Row, Vertical, 1.00mm (.039") Stacking Height, With Solder Tabs, with Vacuum Tape, 90 Circuits



Series

image - Reference only

Documents:

- [3D Model](#)
- [Drawing \(PDF\)](#)
- [RoHS Certificate of Compliance \(PDF\)](#)

General

Product Family	PCB Receptacles
Series	502426
Application	Board-to-Board
Overview	slimstack_mm016_pitch
Product Name	SlimStack™

Physical

Circuits (Loaded)	90
Color - Resin	Black
Durability (mating cycles max)	30
Glow-Wire Compliant	No
Lock to Mating Part	Yes
Mated Height (in)	0.039 In
Mated Height (mm)	1.00 mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Gold
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	Yes
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface (in)	0.016 In
Pitch - Mating Interface (mm)	0.40 mm
Polarized to Mating Part	No
Polarized to PCB	No
Stackable	No
Temperature Range - Operating	-25°C to +85°C
Termination Interface: Style	Surface Mount

Electrical

Current - Maximum per Contact	0.3A
Voltage - Maximum	50V AC/DC

Material Info

Reference - Drawing Numbers

Packaging Specification	SPK-502426-001
Product Specification	RPS-502426-002, RPS-502426-010, RPS-502426-011, RPS-502426-013, RPS-502426-014, RPS-502426-015, RPS-502426-017, RPS-502426-019
Sales Drawing	SD-502426-003, SD-502426-004

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

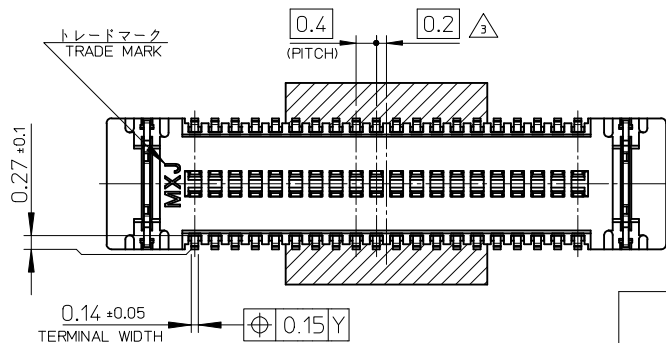
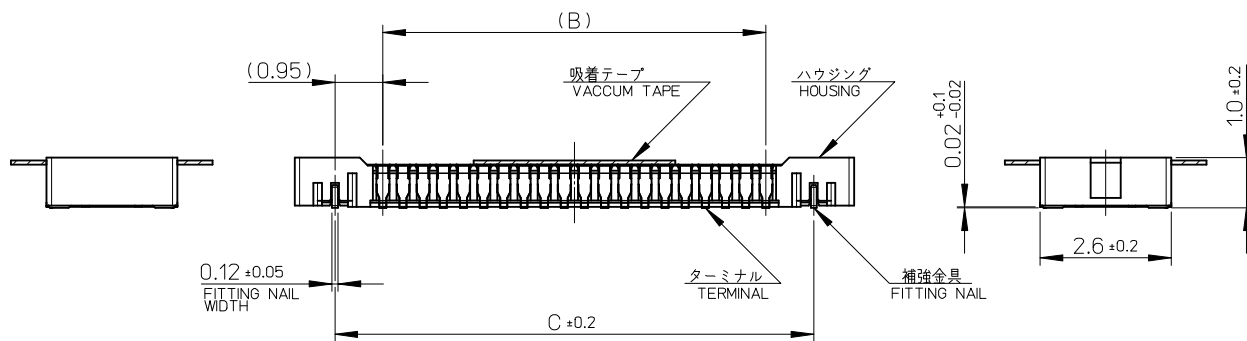
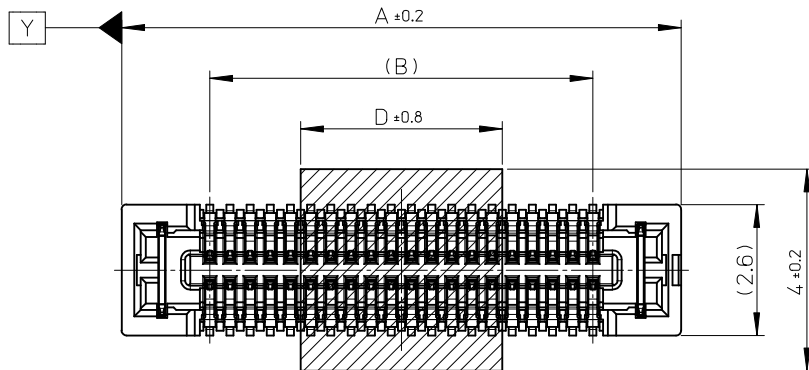
502426Series

Mates With

502430 PCB Header

This document was generated on 05/25/2010

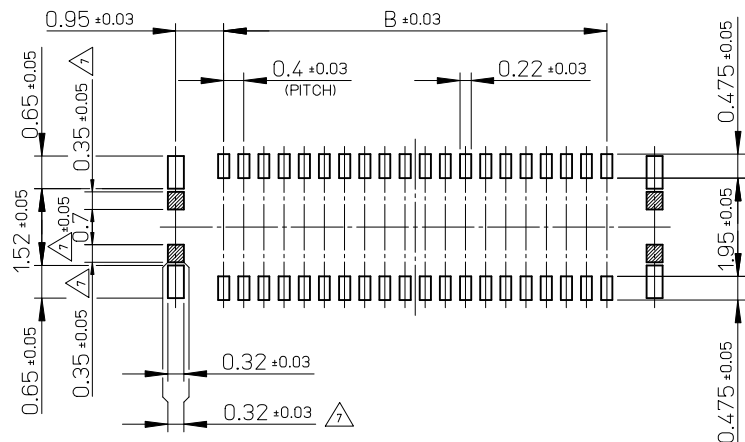
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10.0	19.5	17.6	21.1	502426-9030	90
	17.5	15.6	19.1	502426-8030	80
	15.5	13.6	17.1	502426-7030	70
7.0	13.5	11.6	15.1	502426-6030	60
	11.5	9.6	13.1	502426-5030	50
4.0	9.5	7.6	11.1	502426-4030	40
	7.9	6.0	9.5	502426-3230	32
3.4	6.7	4.8	8.3	502426-2630	26
	6.3	4.4	7.9	502426-2430	24
	5.9	4.0	7.5	502426-2230	22
	5.5	3.6	7.1	502426-2030	20
2.4	4.3	2.4	5.9	502426-1430	14
D	C	B	A	EMBOSSD TAPE PACKAGE ORDER No.	CKT.

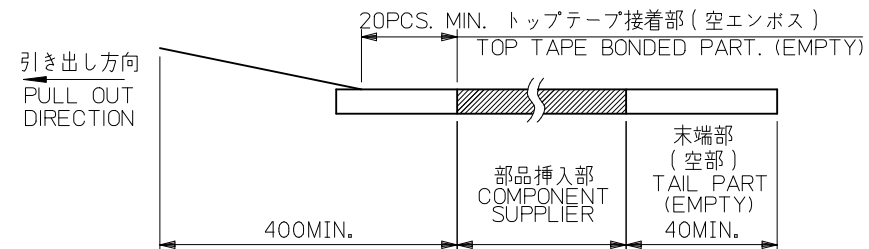
CONNECTOR SERIES No. : 502426-**39

REVISED EC NO: J2009-0889 DRWN:YADYAGI CHKD:THARUYAMA APPR:NUKITA	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER ± ---		DRAWN BY DATE RTAKEUCHI 2007/12/26		TITLE 0.4 B-TO-B CONN. HGT=1.0 W=2.6 REC ASSY WITH TAPE			
		10 OVER 30 UNDER ± ---		CHECKED BY DATE MSASAO 2007/12/26					
		30 OVER ± ---		APPROVED BY DATE MSASAO 2007/12/26					
		ANGULAR ± --- °		MATERIAL NO.		MOLEX INCORPORATED			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		DOCUMENT NO. SD-502426-003			
				SIZE A3		SHEET NO. 1 OF 2			
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

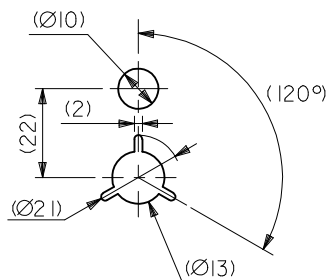
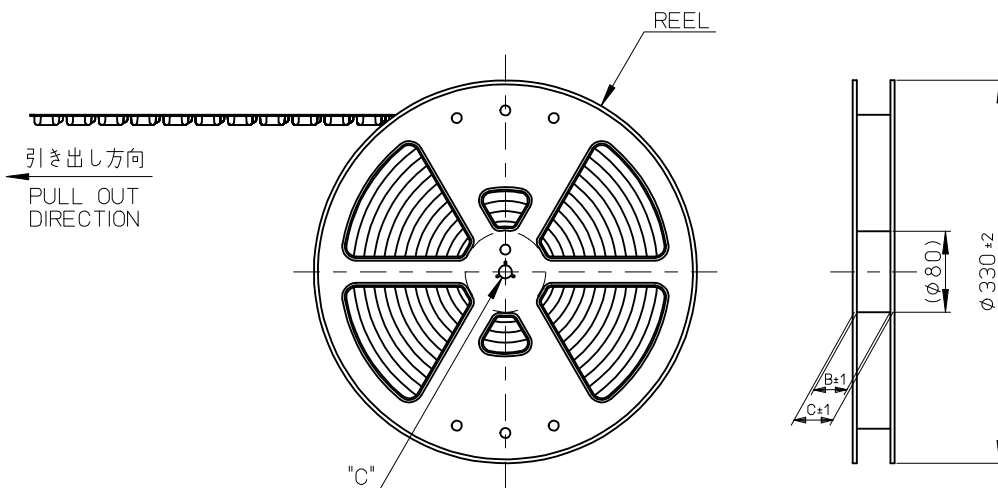


P.C.BOARD PATTERN LAYOUT
(REFERENCE)

- 注記 NOTES
1. 使用材料 MATERIAL
- ハウジング：液晶ポリマー（ LCP ） ガラス充填 UL94V-0（ 黒 ）
HOUSING:LIQUID CRYSTAL POLYMER(GLASS FILLED) UL94V-0 (COLOR:BLACK)
- ターミナル：りん青銅（t=0.1）
TERMINAL：PHOSPHOR BRONZE (t=0.1)
- 金具：りん青銅（t=0.12）
FITTING NAIL：PHOSPHOR BRONZE (t=0.12)
- 吸着テープ：ポリイミド
VACUUM TAPE：POLYIMIDE
2. メッキ仕様 PLATING
- ターミナル TERMINAL
- 金メッキ 0.1 マイクロメートル以上
GOLD 0.1MICROMETER MINIMUM
- 下地メッキ：ニッケルメッキ 1.0 マイクロメートル以上
UNDER PLATING：NICKEL 1.0MICROMETER MINIMUM
- ※コンタクト部とテール部はニッケルメッキによって分断されている金メッキです。
DIVIDE INTO PARTS THE GOLD PLATING OF THE CONTACT
AND THE TAIL PART BY THE NICKEL PLATING.
- ※封孔処理品
- 金具 FITTING NAIL
- フラッシュ金メッキ
FLASH Au PLATING
- 下地メッキ：ニッケルメッキ 1.0 マイクロメートル以上
UNDER PLATING：NICKEL 1.0MICROMETER MINIMUM
- △3（全極数／2）＝偶数の場合に適用。
APPLY FOR (CIRCUIT/2)=EVEN.
4. 嵌合相手： 502430 シリーズ
MATE WITH：502430 SERIES.
5. テール平坦度は、 0.08 以下
テール及び金具の平坦度は、 0.1 以下
TAIL COPLANARITY TO BE 0.08MAXIMUM.
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1MAXIMUM.
6. ELV 及び RoHS適合品
ELV AND RoHS COMPLIANT.
- △7斜線部はパターン書込み禁止範囲と半田禁止範囲を示す。
ただし、斜線部に補強金具と同一配線を配置する場合はレジストを施し、この部分に半田は無きこと。
NO PATTERN CIRCUIT AND NO SOLDER ALLOWED IN THE SHADED AREA.
HOWEVER, IF NEEDED TO ADD A TRACE OF THE SAME CIRCUIT, PUT THE SOLDER-RESIST,
YET NO SOLDER ALLOWED IN THE AREA.



4. 材料 MATERIAL
 キャリアテープ (CARRIER TAPE) : ポリスチレン (POLYSTYRENE)
 トップテープ (TOP TAPE) : PET , PE , PEF
 リール (REEL) : ポリスチレン (PS) <リサイクル材を含む>
 POLYSTYRENE (PS) <RECYCLE MATERIAL CONTAINED>
5. ELV 及び RoHS適合品
 ELV AND RoHS COMPLIANT



DETAIL "C"

REVISED	EC NO: J2009-0889	2009/06/15	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	MODEL NO. 502426-**30	THIRD ANGLE PROJECTION
	DRWN:YA0YAGI	2009/06/15		10 UNDER	± ---	DRAWN BY DATE	TITLE	0.4 B-TO-B CONN. HGT=1.0 REC ASSY WITH TAPE EMBSTP PKG			
	CHKD:THARYAWA	2009/06/15		10 OVER 30 UNDER	± ---	CHECKED BY DATE	MOLEX MOLEX INCORPORATED				
	APPR:NUKI TA	2009/06/15		30 OVER	± ---	APPROVED BY DATE					
	ANGULAR	± --- °		MATERIAL NO.	DOCUMENT NO.	SHEET NO.					
REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE TABLE		SD-502426-004		1 OF 4			
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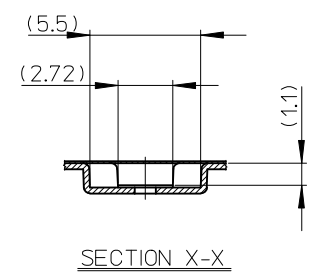
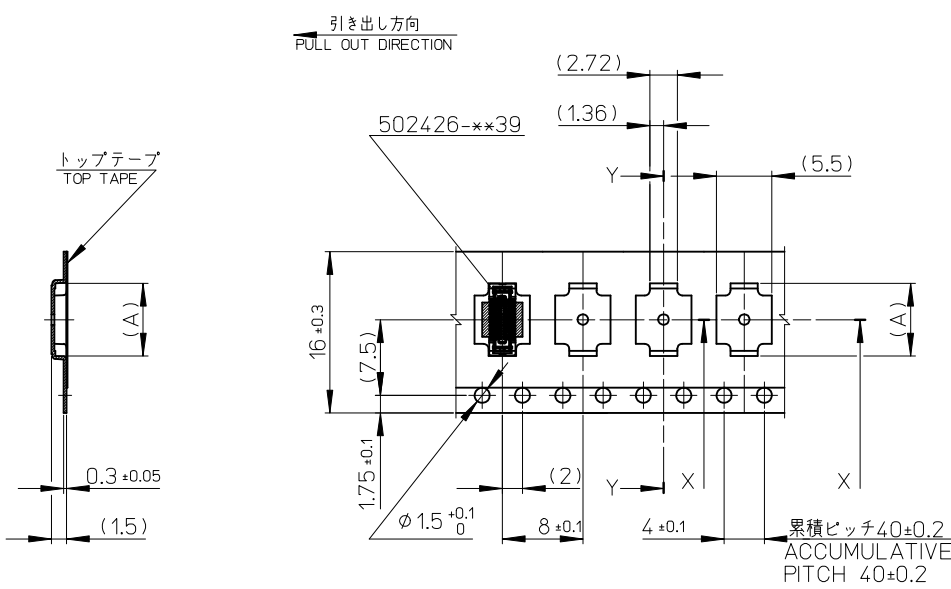
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16mm 幅キャリアテープ
16mm WIDTH CARRIER TAPE

16	21.4	17.4	8.42	502426-2630		26
			8.02	502426-2430		24
			7.62	502426-2230		22
			7.22	502426-2030		20
			6.02	502426-1430		14
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	(A)	MATERIAL No.		CKT.
				MODEL No.	502426-***30	

REVISED EC NO: J2009-0889 DRWN:YAOYAGI CHKD:THARUYAMA APPR:NUKITA C	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
		10 UNDER		± ---		DRAWN BY RTAKEUCHI		DATE 2007/12/26			
		10 OVER 30 UNDER		± ---		CHECKED BY MSASAO		DATE 2007/12/26			
		30 OVER		± ---		APPROVED BY MSASAO		DATE 2007/12/26			
		ANGULAR ± --- °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-502426-004		2 OF 4			
				SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

10 9 8 7 6 5 4 3 2 1

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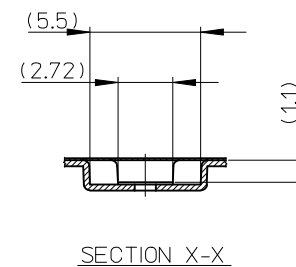
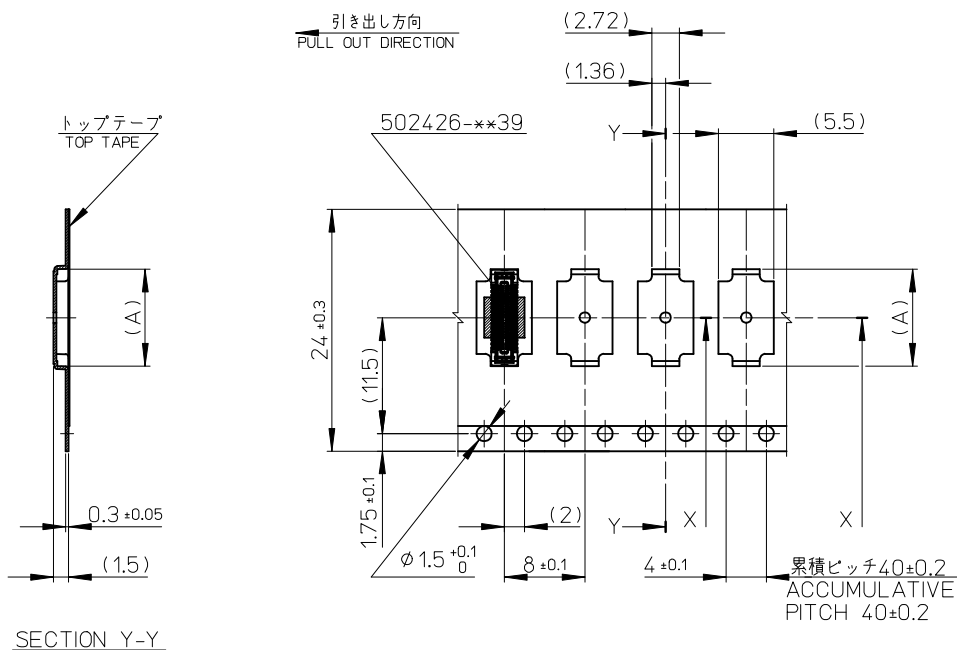
E

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24mm 幅キャリアテープ
24mm WIDTH CARRIER TAPE

24	29.4	25.4	15.22	502426-6030		60
			13.22	502426-5030		50
			11.22	502426-4030		40
			9.62	502426-3230		32
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	(A)	MATERIAL No.		CKT.
				MODEL No.	502426-***30	

REVISED EC NO: J2009-0889 DRWN:YAOYAGI CHKD:THARUYAMA APPR:NUKITA C	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION		
		10 UNDER	± ---	DRAWN BY RTAKEUCHI	DATE 2007/12/26	TITLE 0.4 B-TO-B CONN. HGT=1.0 REC ASSY WITH TAPE EMBSTP PKG				
		10 OVER 30 UNDER	± ---	CHECKED BY MSASAO	DATE 2007/12/26					
		30 OVER	± ---	APPROVED BY MSASAO	DATE 2007/12/26	MOLEX INCORPORATED				
		ANGULAR	± --- °	MATERIAL NO.					DOCUMENT NO.	SHEET NO.
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-502426-004			3 OF 4	
				SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

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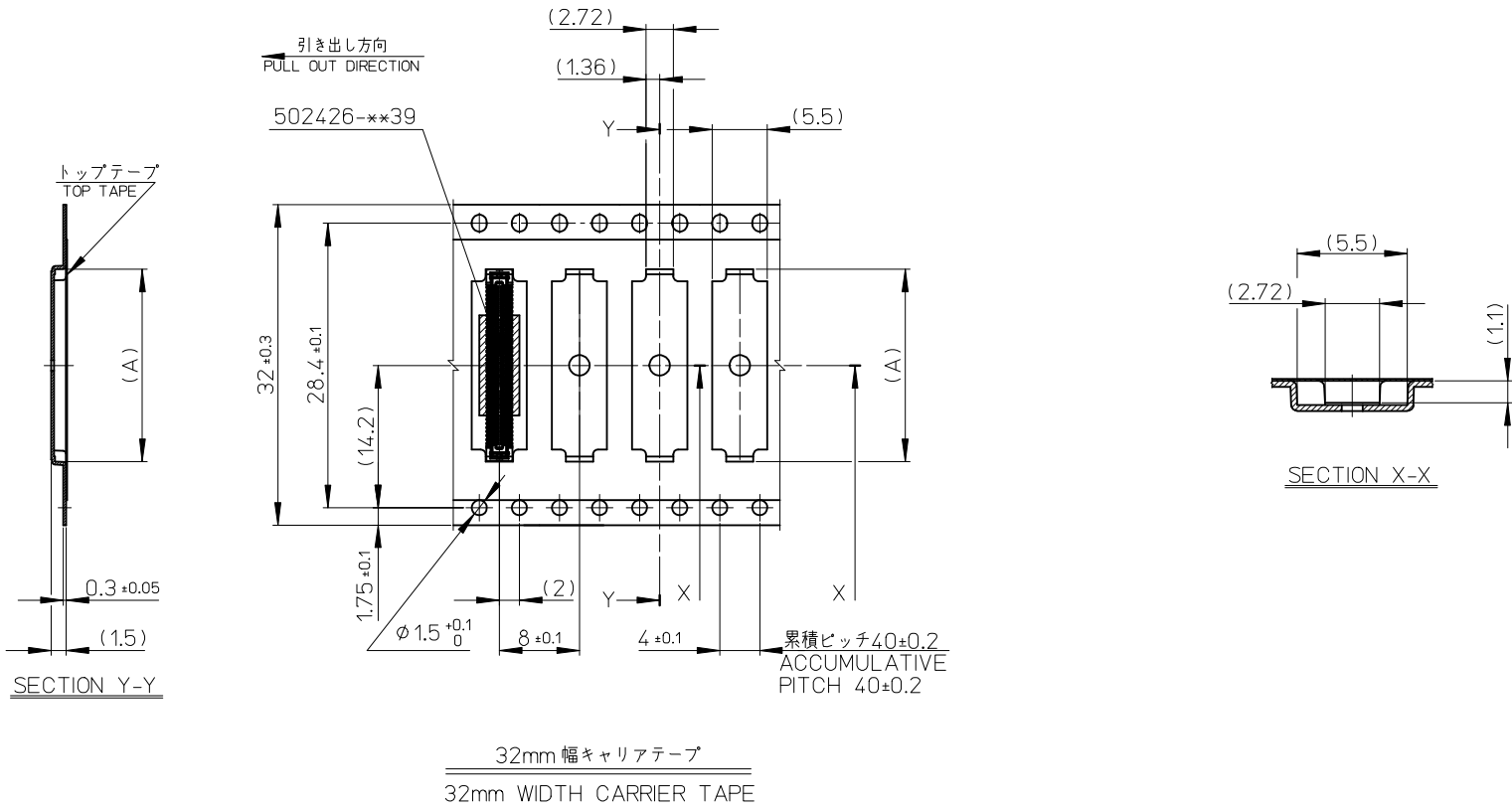
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32	37.4	33.5	21.22	502426-9030		90
			19.22	502426-8030		80
			17.22	502426-7030		70
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	(A)	MATERIAL No.		CKT.
				MODEL No.	502426-**30	

REVISED EC NO.: J2009-0889 DRWN: YAOYAGI CHKD: THARUYAMA APPR: NUKITA C	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
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		10 OVER 30 UNDER	± ---	CHECKED BY	DATE					
		30 OVER	± ---	APPROVED BY	DATE	MOLEX INCORPORATED				
		ANGULAR	± --- °	MATERIAL NO.						
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		DOCUMENT NO. SD-502426-004		SHEET NO. 4 OF 4		
				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

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<http://moschip.ru/get-element>

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

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